

MOSFETs Silicon N-channel MOS (U-MOSVIII-H)

# TK65A10N1



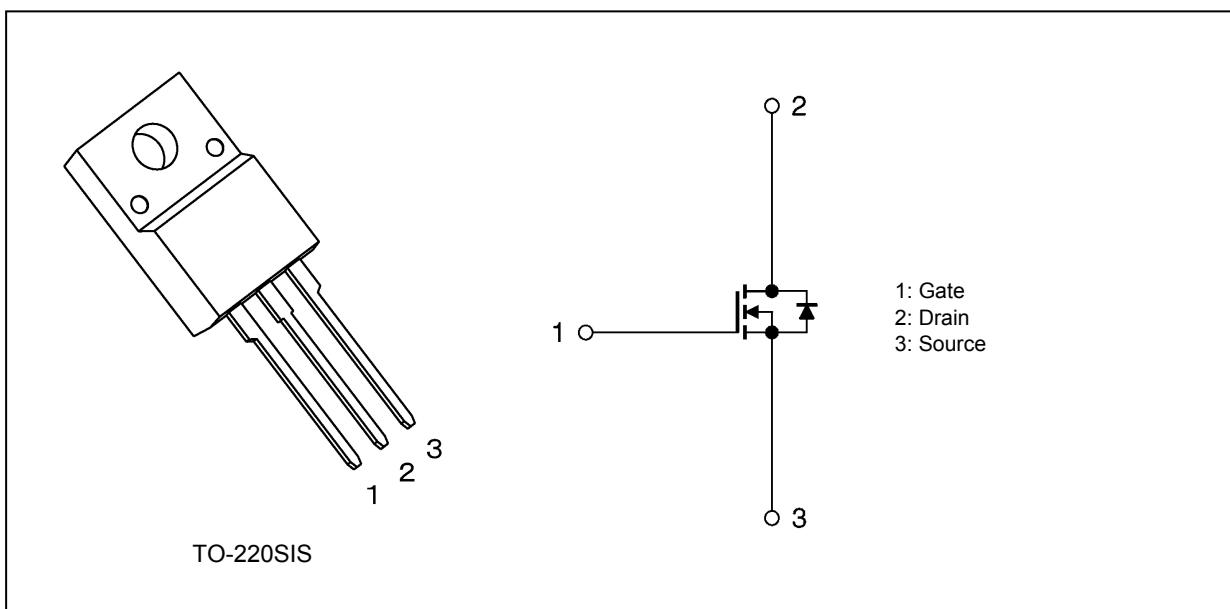
## 1. Applications

- Switching Voltage Regulators

## 2. Features

- (1) Low drain-source on-resistance:  $R_{DS(ON)} = 4.0 \text{ m}\Omega$  (typ.) ( $V_{GS} = 10 \text{ V}$ )
- (2) Low leakage current:  $I_{DSS} = 10 \mu\text{A}$  (max) ( $V_{DS} = 100 \text{ V}$ )
- (3) Enhancement mode:  $V_{th} = 2.0$  to  $4.0 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1.0 \text{ mA}$ )

## 3. Packaging and Internal Circuit



## 4. Absolute Maximum Ratings (Note) ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	100	V
Gate-source voltage	$V_{GSS}$	$\pm 20$	
Drain current (DC) (Silicon limit)	$I_D$	148	A
Drain current (DC) ( $T_c = 25^\circ\text{C}$ )	$I_D$	65	
Drain current (pulsed) ( $t = 1 \text{ ms}$ )	$I_{DP}$	296	
Power dissipation ( $T_c = 25^\circ\text{C}$ )	$P_D$	45	W
Single-pulse avalanche energy	$E_{AS}$	143	mJ
Avalanche current	$I_{AR}$	65	A
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

## 6. Electrical Characteristics

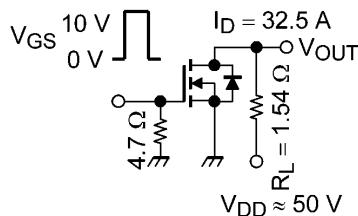
### 6.1. Static Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	—	—	$\pm 0.1$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	100	—	—	$\text{V}$
Drain-source breakdown voltage (Note 4)	$V_{(BR)DSX}$	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	65	—	—	
Gate threshold voltage	$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1.0 \text{ mA}$	2.0	—	4.0	
Drain-source on-resistance	$R_{DS(\text{ON})}$	$V_{GS} = 10 \text{ V}, I_D = 32.5 \text{ A}$	—	4.0	4.8	$\text{m}\Omega$

Note 4: If a reverse bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode. Note that the drain-source breakdown voltage is lowered in this mode.

### 6.2. Dynamic Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	—	5400	—	$\text{pF}$
Reverse transfer capacitance	$C_{rss}$		—	42	—	
Output capacitance	$C_{oss}$		—	950	—	
Gate resistance	$r_g$	—	—	2.4	—	$\Omega$
Switching time (rise time)	$t_r$	See Figure 6.2.1	—	19	—	$\text{ns}$
Switching time (turn-on time)	$t_{on}$		—	44	—	
Switching time (fall time)	$t_f$		—	26	—	
Switching time (turn-off time)	$t_{off}$		—	85	—	



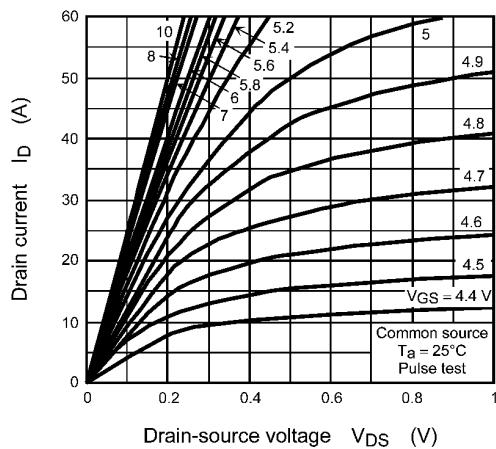
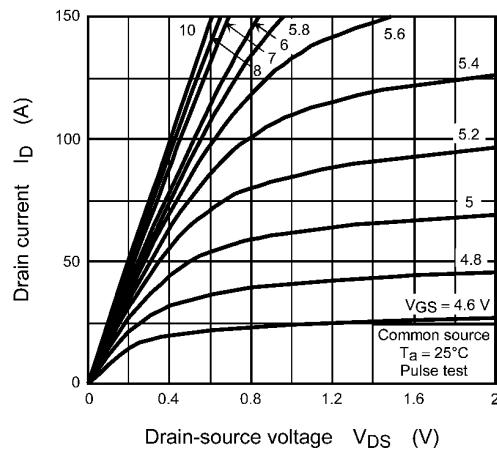
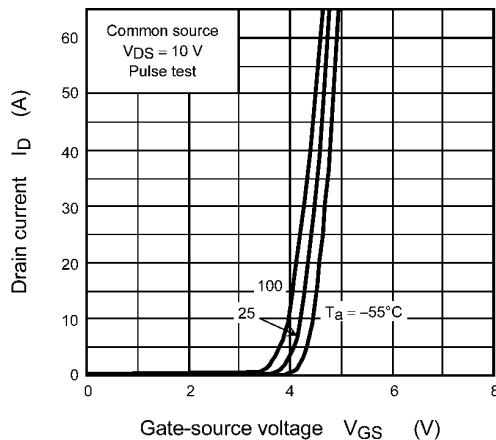
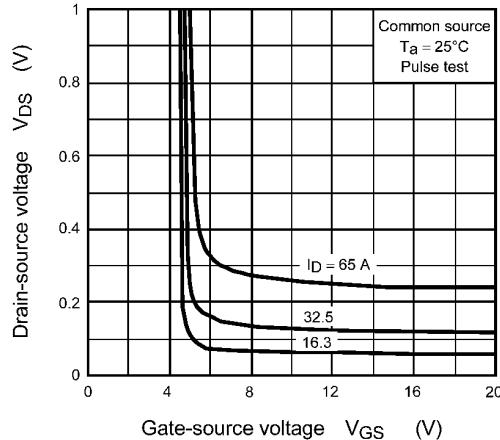
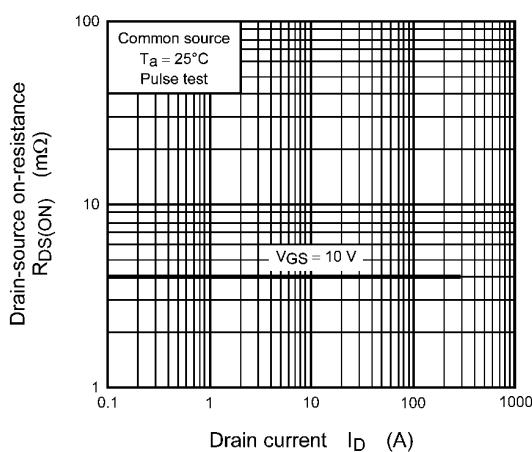
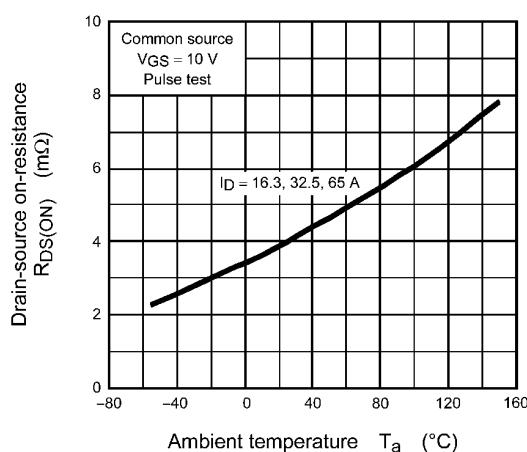
Duty  $\leq 1\%$ ,  $t_w = 10 \mu\text{s}$

Fig. 6.2.1 Switching Time Test Circuit

### 6.3. Gate Charge Characteristics ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 80 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 65 \text{ A}$	—	81	—	$\text{nC}$
Gate-source charge 1	$Q_{gs1}$		—	31	—	
Gate-drain charge	$Q_{gd}$		—	18	—	
Gate switch charge	$Q_{sw}$		—	32	—	

## 8. Characteristics Curves (Note)

Fig. 8.1  $I_D$  -  $V_{DS}$ Fig. 8.2  $I_D$  -  $V_{DS}$ Fig. 8.3  $I_D$  -  $V_{GS}$ Fig. 8.4  $V_{DS}$  -  $V_{GS}$ Fig. 8.5  $R_{DS(\text{ON})}$  -  $I_D$ Fig. 8.6  $R_{DS(\text{ON})}$  -  $T_a$